

SOD123FL Plastic-Encapsulate Diodes

Schottky Rectifier

Features

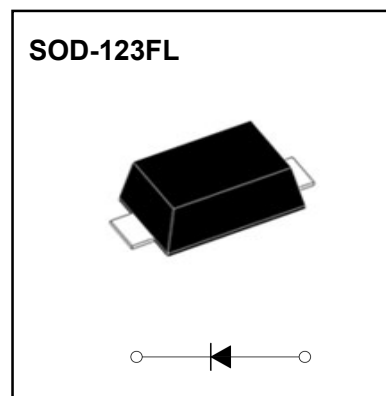
- I_o 1A
- V_{RRM} 100V
- High surge current capability
- Polarity: Color band denotes cathode
- Low V_f

Applications

- Rectifier

Marking

- DSS110L : S110L



Limiting Values (Absolute Maximum Rating)

Item	Symbol	Unit	Conditions	DSS110L
Repetitive Peak Reverse Voltage	V_{RRM}	V		100
Maximum RMS Voltage	V_{RMS}	V		70
Average Forward Current	$I_{F(AV)}$	A	60Hz Half-sine wave, Resistance load	1.0
Surge(Non-repetitive)Forward Current	I_{FSM}	A	60Hz Half-sine wave,1 cycle, $T_a=25^{\circ}\text{C}$	50
Junction Temperature	T_J	$^{\circ}\text{C}$		-55~+150
Storage Temperature	T_{STG}	$^{\circ}\text{C}$		-55~+150

Electrical Characteristics ($T_a=25^{\circ}\text{C}$ Unless otherwise specified)

Item	Symbol	Unit	Test Condition		DSS110L
Peak Forward Voltage	V_F	V	$I_F=1\text{A}$	$T_a=25^{\circ}\text{C}$	0.75
Peak Reverse Current	I_{RRM1}	mA	$V_{RM}=V_{RRM}$	$T_a=25^{\circ}\text{C}$	0.01
	I_{RRM2}			$T_a=100^{\circ}\text{C}$	5
Thermal Resistance(Typical)	$R_{\theta J-A}$	$^{\circ}\text{C/W}$	Between junction and ambient		54
	$R_{\theta J-L}$		Between junction and lead		10
Juction Capacitance (Typical)	C_j	pF	Measured at 1MHZ and Applied Reverse Voltage of 4.0 V.D.C		53

Notes:

Thermal resistance from junction to ambient and from junction to lead mounted on FR4 PCB double sided copper mini pad

Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

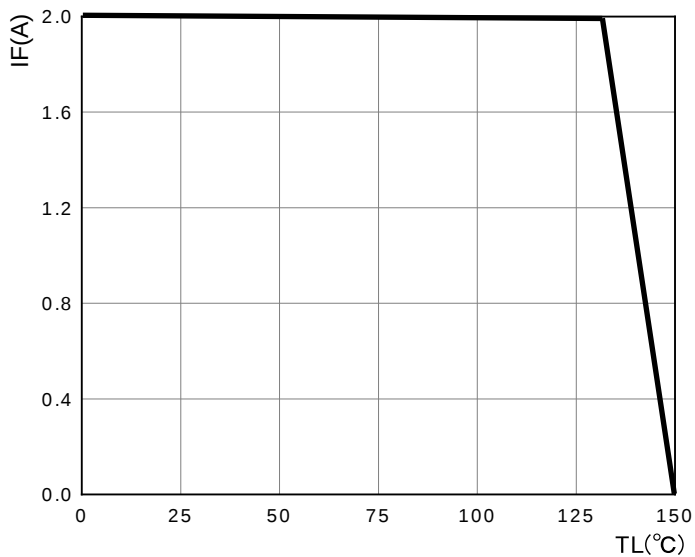


FIG 2: MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

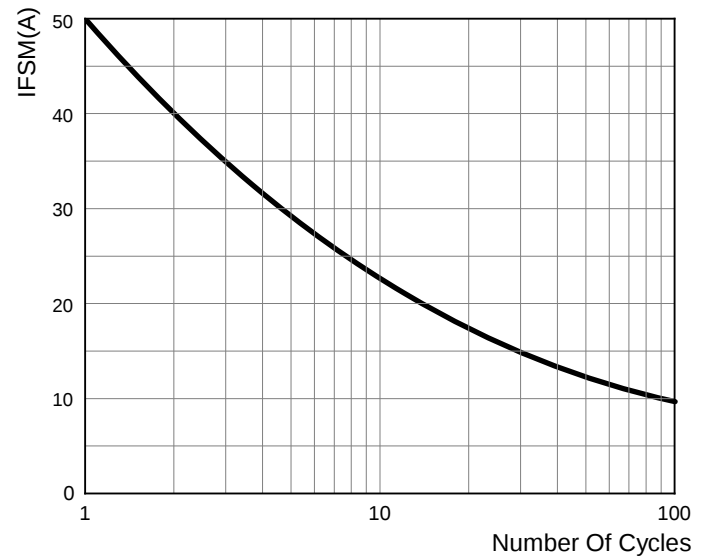


FIG.3: TYPICAL FORWARD CHARACTERISTICS

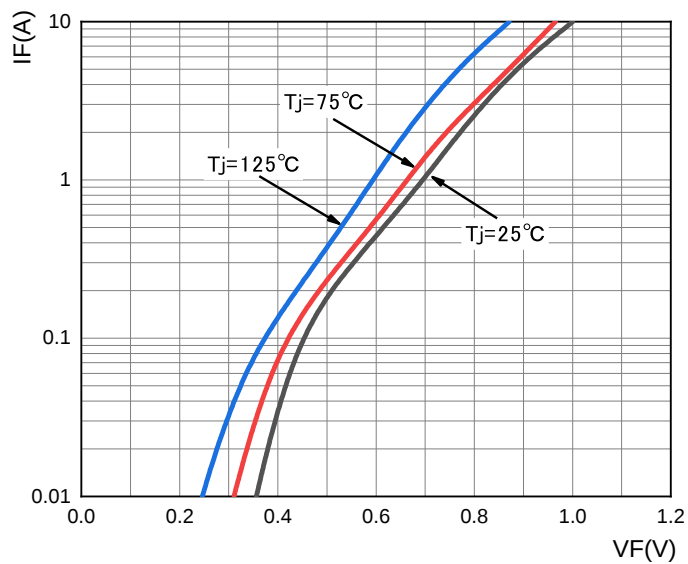
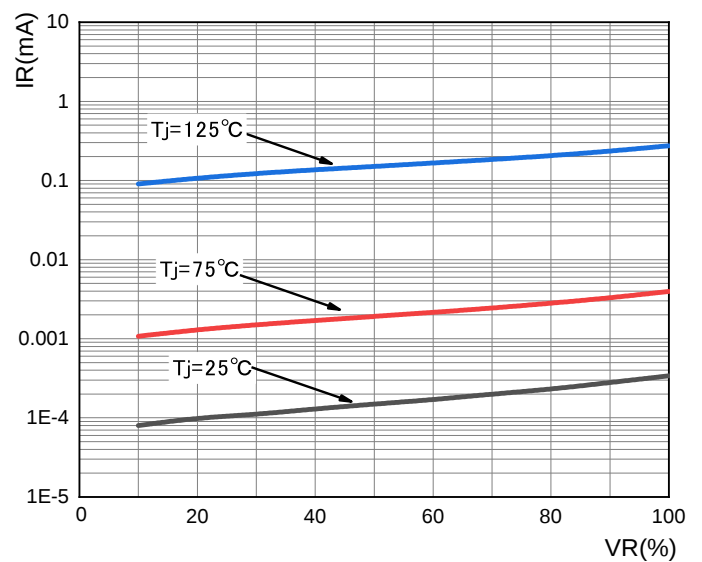
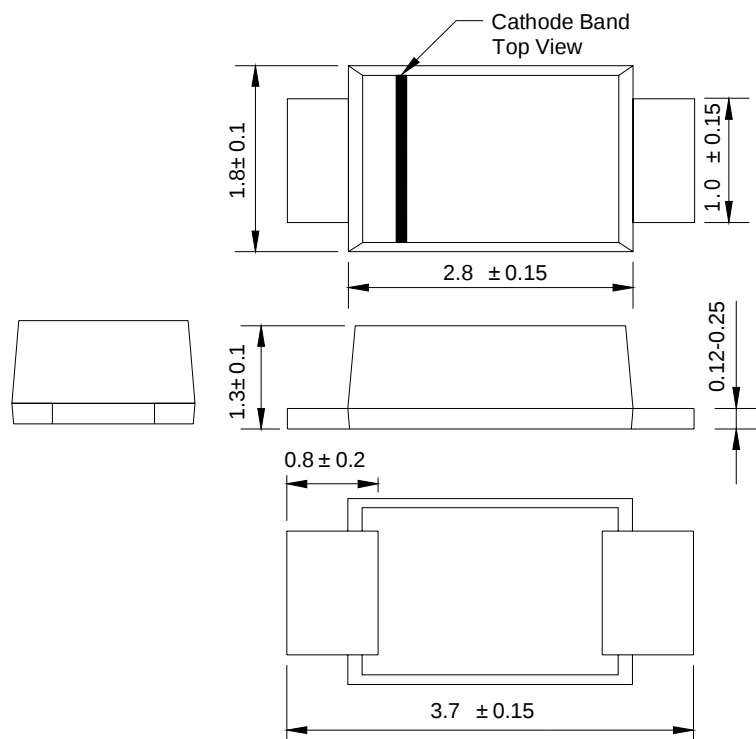


FIG.4: TYPICAL REVERSE CHARACTERISTICS

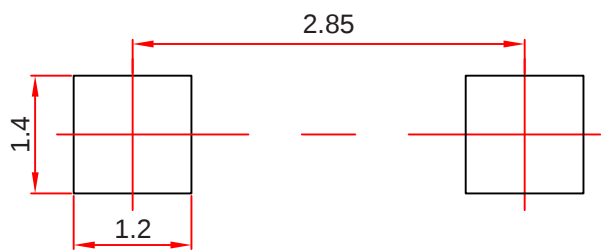


SOD-123FL Package Outline Dimensions



Dimensions in millimeters

SOD-123FL Suggested Pad Layout



- Note:**
- 1. Controlling dimension: in millimeters.
 - 2. General tolerance: ± 0.05 mm.
 - 3. The pad layout is for reference purposes only.

NOTICE

JSHD reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. JSHD does not assume any liability arising out of the application or use of any product described herein.

Reel Taping Specifications For Surface Mount Devices–SOD-123FL



FIG:CONFIGURATION OF AXIAL TAPING

ITEM	SYMBOL	SOD-123FLmm(inch)
Carrier width	A	2.05±0.1(0.081±0.004)
Carrier length	B	3.95±0.1(0.156±0.004)
Carrier depth	C	1.45±0.1(0.057±0.004)
Sprocket hole	d	1.55±0.05(0.061±0.002)
Reel outside diameter	D	178±2.0(7.0±0.079)
Reel inner diameter	D1	54±1.0(2.13±0.039)
Feed hole diameter	D2	13±0.5(0.512±0.020)
Sprocket hole position	E	1.75±0.1(0.069±0.004)
Punch hole position	F	3.50±0.1(0.138±0.002)
Punch hole pitch	P	4.0±0.1(0.157±0.004)
Sprocket hole pitch	P0	4.0±0.1(0.157±0.004)
Embossment center	P1	2.0±0.1(0.079±0.004)
Total tape thickness	T	0.21±0.25(0.008±0.010)
Tape width	W	8.0±0.2(0.315±0.008)
Reel width	W1	10.0±2.0(0.394±0.079)

NOTE:Devices are packde in accordance with EIA standard RS-481-A and specification given above.